



Material Content Data Sheet



Sales Product Name		IPD60R1K5CE		Issued		4. July 2019		
MA#		MA005342334						
Package		PG-TO252-3-343		Weight*		311.20 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.624	0.52	0.52	5219	5219
leadframe	inorganic material	phosphorus	7723-14-0	0.041	0.01		132	
	non noble metal	iron	7439-89-6	0.137	0.04		441	
	non noble metal	copper	7440-50-8	137.105	44.06	44.11	440568	441141
	non noble metal	aluminium	7429-90-5	0.436	0.14	0.14	1402	1402
wire	non noble metal	aluminium	7429-90-5	0.436	0.14	0.14	1402	1402
encapsulation	organic material	carbon black	1333-86-4	1.331	0.43		4277	
	plastics	epoxy resin	-	25.289	8.13		81262	
	inorganic material	silicondioxide	60676-86-0	106.478	34.22	42.78	342154	427693
leadfinish	non noble metal	tin	7440-31-5	3.834	1.23	1.23	12318	12318
solder	non noble metal	tin	7440-31-5	0.038	0.01		121	
	noble metal	silver	7440-22-4	0.047	0.02		152	
	non noble metal	lead	7439-92-1	1.802	0.58	0.61	5792	6065
heatspreader	inorganic material	phosphorus	7723-14-0	0.010	0.00		32	
	non noble metal	iron	7439-89-6	0.033	0.01		106	
	non noble metal	copper	7440-50-8	32.995	10.60	10.61	106024	106162
*deviation	< 10%				Sum in total:		100.00	1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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